



Size 20161A

FEATURES

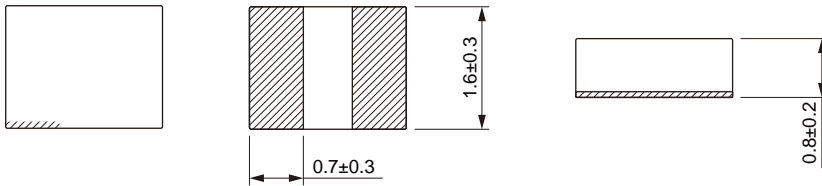
- High current, low DCR, high efficiency.
- Very low acoustic noise and very low leakage flux noise.
- AEC-Q200 qualified
- 100% Lead(Pb)-Free and RoHS compliant.
- Operating temperature: -55 to +155 °C (including self-temperature rise)
- Quantity: 3000PCS

APPLICATION

- ADAS
- Headlamps, tail lamps and interior lighting
- HVAC
- Doors, window lift and seat control
- Audio subsystem
- Digital instrument cluster
- In-Vehicle Infotainment and navigation

Dimensions: [mm]

Land Pattern: [mm]



Electrical Properties:

Part No	Inductance @ 100KHz/1V (μ H)	Tolerance	Temperature Rise Current Typ. (A)	Temperature Rise Current Max. (A)	Satura on Current Typ. (A)	Satura on Current Max. (A)	DC Resistance Typ. (m Ω)	DC Resistance Max. (m Ω)
MDTA20161A-R24M	0.24	±20%	6.8	6.2	7.3	7.0	15	18
MDTA20161A-R33M	0.33	±20%	6.5	6.0	7.0	6.5	17	20
MDTA20161A-R47M	0.47	±20%	6.0	5.5	6.3	5.5	19	22
MDTA20161A-R68M	0.68	±20%	5.0	4.5	5.2	4.7	24	31
MDTA20161A-1R0M	1.00	±20%	4.0	3.7	4.8	4.2	38	46



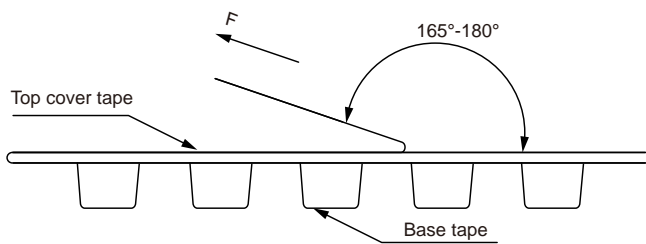
Soldering Reflow:

Packaging Information:

Tape Dimension:

Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
MDTA20161A	1.9± 0.1	2.3± 0.1	1.5± 0.1	4.0± 0.1	4± 0.1	8.0± 0.3	1.2± 0.1	1.75± 0.1	0.25± 0.05

Peel force of top cover tape:



The peel force of top cover tape shall be between 0.1 to 0.98 N



Reel Dimension: [mm]



Cautions and Warnings:

Storage Conditions :

- The storage period is within 12 months after the completion of production. Be sure to follow the storage conditions (temperature: -5 to 35°C, humidity: 75% RH Max).If the storage period elapses, the soldering of the terminal electrodes may deteriorate.The warranty period is one year.
- Product should not be exposed to environment with high temperature, high humidity, dust, corrosive gas and etc.
- Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- Please always handle products carefully to prevent any damage caused by dropping down or inappropriate removing.

Operation Instructions:

- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- Before soldering, be sure to preheat components.The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C.
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